## PATENT ASSIGNMENT COVER SHEET

# Electronic Version v1.1 Stylesheet Version v1.2

### EPAS ID: PAT2677506

SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PART	ΓΥ DATA				
		Name	Execution Date		
WOO-JEONG OH			12/30/2013		
YONG CHUN			12/30/2013		
EUNG-SOO KIM			12/27/2013		
MIN NAM			12/27/2013		
HYEON-DON KIM			12/30/2013		
GI-DAE CHOI			12/27/2013		
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PROPERTY NUMB	ERS Total: 1				
Property Type		Number			
Application Number	er:	14232241			
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Date:		01/10/2014			
Total Attachments: 5 source=Assignment-MOBHAN_020APC#page1.tif source=Assignment-MOBHAN_020APC#page2.tif source=Assignment-MOBHAN_020APC#page3.tif					

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#### ASSIGNMENT

WHEREAS, I/We, the undersigned, have invented certain new and useful improvements entitled

### "POLYOLEFIN-BASED THERMOPLASTIC ELASTOMER COMPOSITE AND COVER MATERIAL FOR AN AIR BAG USING SAME, AND AIR BAG MODULE USING THE COVER MATERIAL,"

for which I/We have executed a Declaration for a U.S. Patent Application on the same date hereof or for which I/We filed U.S. Patent Application No. \_\_\_\_\_\_\_\_ on \_\_\_\_\_\_\_\_. In case this document is signed after the filing date and is provided without the filing date and/or the application number, I/We authorize the registrants of Knobbe, Martens, Olson & Bear, LLP, Customer No. 20,995 to include the filing date and application number in the blanks before filing this document for recordation with the United States Patent and Trademark Office.

AND WHEREAS, **HYUNDAI MOBIS CO., LTD.**, with its principal place of business at ING Tower, 679-4, Yeoksam 1-dong, Gangnam-gu, Seoul 135-977, Republic of Korea; and **LG CHEM, LTD.**, with its principal place of business at 128, Yeoui-daero, Yeongdeungpo-gu, Seoul 150-721, Republic of Korea (hereinafter "ASSIGNEES"), desire to acquire the entire right, title, and interest in and to the said improvements and the said Application.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I/We do hereby acknowledge that I/We have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEES, its successors, legal representatives and assigns, the entire right, title, and interest, to and under the said improvements, and the said Application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof; and I/We hereby authorize and request the Commissioner of Patents of the United States of America to issue all Letters Patent for said improvements to the said ASSIGNEES, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE DO HEREBY sell, assign, transfer, and convey to ASSIGNEES, his successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEES, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of the said Letters Patent before or after issuance.

AND I/WE HEREBY covenant and agree that I/We will communicate to the said ASSIGNEES, successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEES, successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Client	Code:	
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Name: OH, Woo-Jeong

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10191559:mk 122010

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10191559:mk 122010

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PATENT REEL: 031945 FRAME: 0106

**RECORDED: 01/10/2014**